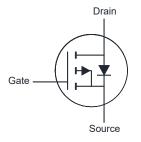
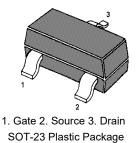
P-Channel Enhancement Mode MOSFET

Features

• Surface-mounted package





Applications

- Portable appliances
- Battery management

Absolute Maximum Ratings(at Ta = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	-V _{DS}	30	V
Gate-Source Voltage	V _{GS}	± 20	V
Drain Current	-I _D	5.8	Α
Peak Drain Current, Pulsed 1)	-І _{DМ}	30	Α
Total Power Dissipation 2)	P _{tot}	1	W
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150	°C

Thermal Characteristics

Parameter	Symbol	Max.	Unit	
Thermal Resistance from Junction to Ambient 2)	Reja	125	°C/W	

 $^{^{1)}}$ Pulse Test: Pulse Width ≤ 100 μs, Duty Cycle ≤ 2%, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ = 150°C.



²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

MKA03P055L

Characteristics at Ta = 25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS			ı	ı	
Drain-Source Breakdown Voltage at -I _D = 250 μA	-BV _{DSS}	30	-	-	V
Drain-Source Leakage Current at -V _{DS} = 24 V	-I _{DSS}	-	-	1	μA
Gate Leakage Current at V _{GS} = ± 16 V	I _{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $-I_D = 250 \mu A$	-V _{GS(th)}	1.2	-	2.5	V
Drain-Source On-State Resistance at -V _{GS} = 10 V, -I _D = 4 A at -V _{GS} = 4.5 V, -I _D = 2 A	R _{DS(on)}	- -	-	35 55	mΩ
DYNAMIC PARAMETERS	ı		1	T	
Forward Transconductance at -V _{DS} = 5 V, -I _D = 4 A	g fs	-	9.5	-	S
Gate resistance at $V_{DS} = 0 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	Rg	-	4.8	-	Ω
Input Capacitance at $V_{GS} = 0 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	C _{iss}	-	1195	-	pF
Output Capacitance at $V_{GS} = 0 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	Coss	-	125	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0 \text{ V}$, $-V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	Crss	-	94	-	pF
Total Gate Charge at -V _{DS} = 15 V, -I _D = 4 A, -V _{GS} = 10 V at -V _{DS} = 15 V, -I _D = 4 A, -V _{GS} = 4.5 V	Qg	- -	19.7 9	- -	nC
Gate to Source Charge at $-V_{DS} = 15 \text{ V}$, $-I_D = 4 \text{ A}$, $-V_{GS} = 10 \text{ V}$	Q _{gs}	-	4.7	-	nC
Gate to Drain Charge at $-V_{DS} = 15 \text{ V}$, $-I_D = 4 \text{ A}$, $-V_{GS} = 10 \text{ V}$	Q_{gd}	-	3	-	nC
Turn-On Delay Time at -V _{DS} = 15 V, -V _{GS} = 10 V, -I _D = 4 A, R _g = 3.3 Ω	$t_{d(on)}$	-	9.3	-	nS
Turn-On Rise Time at -V _{DS} = 15 V, -V _{GS} = 10 V, -I _D = 4 A, R _g = 3.3 Ω	tr	-	31	-	nS
Turn-Off Delay Time at -V _{DS} = 15 V, -V _{GS} = 10 V, -I _D = 4 A, R _g = 3.3 Ω	t _{d(off)}	-	14	-	nS
Turn-Off Fall Time at -V _{DS} = 15 V, -V _{GS} = 10 V, -I _D = 4 A, R _g = 3.3 Ω	t _f	-	2.8	-	nS
Body-Diode PARAMETERS					
Body Diode Voltage at -ls = 1 A, V _{GS} = 0 V	-V _{SD}	-	-	1.2	V
Body-Diode Continuous Current	-Is			5.8	Α
Body Diode Reverse Recovery Time at -ls = 4 A, di/dt = 100 A / µs	t _{rr}	-	9.7	-	nS
Body Diode Reverse Recovery Charge at -l _s = 4 A, di/dt = 100 A / µs	Q _{rr}	-	4	-	nC



Electrical Characteristics Curves

Fig. 1 Typical Output Characteristics

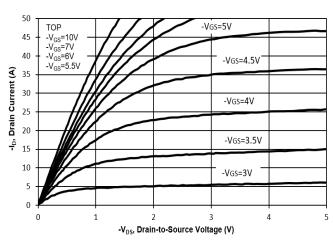


Fig. 2 Typical Transfer Characteristics

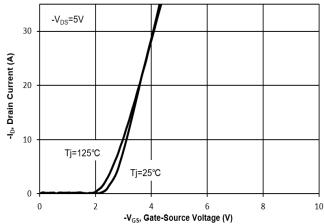
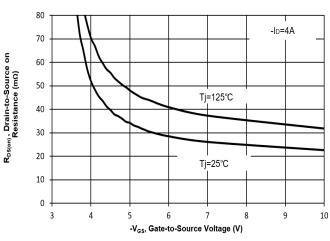


Fig. 4 On-Resistance vs. Gate-Source Voltage



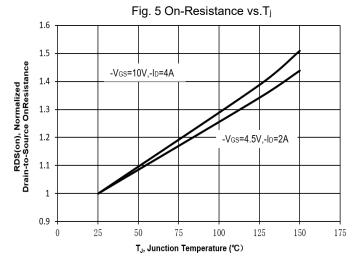
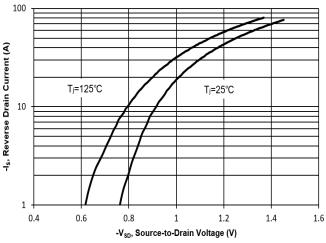


Fig. 6 Typical Body-Diode Forward Characteristics





Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

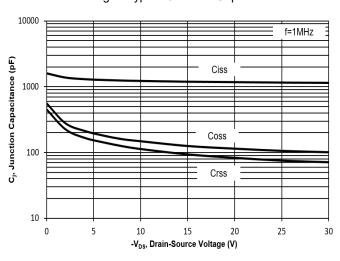


Fig. 8 Drain-Source Leakage Current vs. Tj

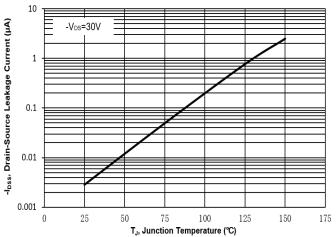
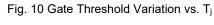
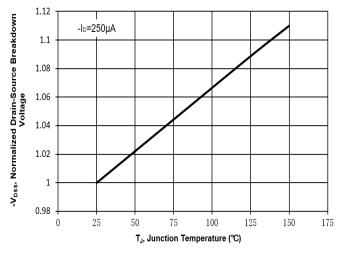


Fig. 9 $V_{(BR)DSS}$ vs. Junction Temperature





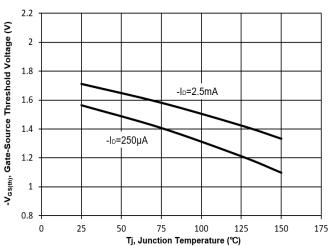
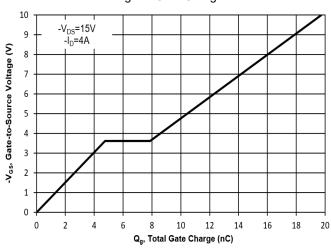
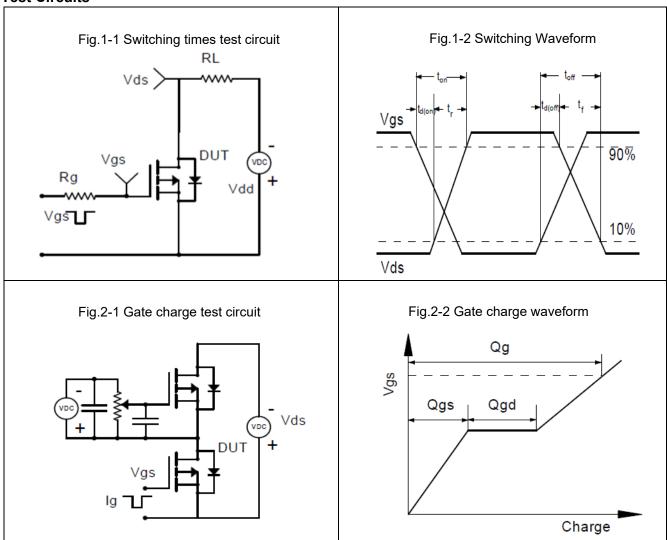


Fig. 11 Gate Charge





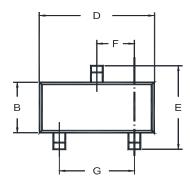
Test Circuits

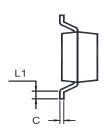


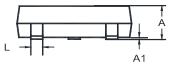


Package Outline (Dimensions in mm)

SOT-23

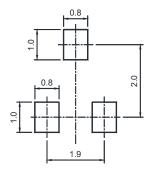






Unit	Α	A1	В	С	D	E	F	G	L	L1
	1.20	0.100	1.40	0.19	3.04	2.6	1.02	2.04	0.51	0.2
mm	0.89	0.013	1.20	0.08	2.80	2.2	0.89	1.78	0.37	MIN

Recommended Soldering Footprint



Packing information

Package Tape Width (mm)		Pit	tch	Reel	Size	
		mm	inch	mm	inch	Per Reel Packing Quantity
SOT-23	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

Marking information

" VZ1 " = Part No.

" YM " = Date Code Marking

" Y " = Year

" M " = Month

Font type: Arial



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